

**SPECIFICATION** 









# B2D06065K

#### 650V ▲ 6A ▲ SIC SCHOTTKY DIODE

SILICON CARBIDE SIC SCHOTTKY DIODE ▲ THT type

Excellent surge capability
Easy paralleling due to positive V<sub>F</sub> temperature coefficient

TO-220-2L package ▲ Epoxy meets UL94-V0

Temperature independent switching
Ultra-low forward voltage and high surge current

Item (T <sub>C</sub> = 25°C, unless otherwise noted)		Characteristics
Operating Temperature Range	Tj	-55°C to +175°C
Storage Temperature Range	Ts	-55°C to +175°C
Repetitive Peak Reverse Voltage	$V_{RRM}$	650V
Continuous Forward Current at T <sub>c</sub> = 160°C	I <sub>F</sub>	6A
Total Capacitive Charge (T <sub>J</sub> = 25°C)	$\mathbf{Q}_{c}$	17nC
Capacitance Stored Energy (V <sub>R</sub> = 400V)	Ec	4.5µJ
Diode Forward Voltage (T <sub>J</sub> = 175°C, I <sub>F</sub> = 6A)	V <sub>F</sub>	1.63V
Power Dissipation	P <sub>TOT</sub>	119W

#### **APPLICATIONS**

EV Charging	Industrial Inverters	Motors & Drives	Power Factor Correction	Renewable Energy	SMPS	UPS
<b>₹</b> /•			PFC	*		

#### **PIN DESCRIPTION**

Circuit Diagram	Outline • Front View	Pin No.	Description
Case 0 1 2	Case	1 2	Cathode (Case Backside) Anode

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# ABSOLUT MAXIMUM RATINGS ▲ T<sub>C</sub> = 25°C, unless otherwise noted

ltem	Condition	Symbol		Unit
Repetitive Peak Reverse Voltage		$V_{RRM}$	650	V
Non-Repetitive Peak Reverse Voltage		$V_{RSM}$	650	V
Continuous Forward Current	T <sub>C</sub> = 25°C	I <sub>F</sub>	26	Α
Continuous Forward Current	$T_C = 160^{\circ}C$	IF	6	Α
Non-Repetitive Forward Surge Current	$T_C$ = 25°C, $t_p$ = 10ms, Half Sine Wave	I <sub>FSM</sub>	48	Α
I <sup>2</sup> t Value	$T_C = 25^{\circ}C$ , $t_p = 10$ ms	∫i²dt	11.52	$A^2s$
Power Dissipation	T <sub>C</sub> = 25°C	$P_{TOT}$	119	W
Power Dissipation	T <sub>C</sub> = 110°C	$P_{TOT}$	51	W
Operating Junction Temperature		TJ	-55 to +175	°C
Storage Temperature Range		$T_{STG}$	-55 to +175	°C
TO-220 Mounting Torque	M3 Screw		0.7	Nm

#### **ELECTRICAL CHARACTERISTICS**

Item	Condition	Symbol	Min.	Тур.	Max.	Unit
Static Characteristics						
DC Blocking Voltage	T <sub>J</sub> = 25°C	$V_{DC}$	650			V
Diode Forward Voltage	$I_F = 6A, T_J = 25^{\circ}C$	$V_{F}$		1.33	1.50	V
Diode Forward Voltage	I <sub>F</sub> = 6A, T <sub>J</sub> = 175°C	$V_{F}$		1.63	2.20	V
Reverse Current	$V_R = 650V$ , $T_J = 25$ °C	$I_R$		1	50	μΑ
Reverse Current	$V_R = 650V, T_J = 175^{\circ}C$	I <sub>R</sub>		15	150	μΑ
Item	Condition	Symbol	Min.	Тур.	Max.	Unit
Dynamic Characteristics						
	$V_R = 400V, T_J = 25^{\circ}C$					
Total Capacitive Charge	$Q_C = \int_0^{V_R} C(V) dV$	Qc		17		nC
Total Capacitance	$V_R = 1V$ , $f = 1MHz$ , $T_1 = 25$ °C	С		271		pF
Total capacitation						
Total Capacitance	V <sub>R</sub> = 300V, f = 1MHz, T <sub>J</sub> = 25°C	С		30.1		pF
·	$V_R = 300V, f = 1MHz, T_J = 25^{\circ}C$ $V_R = 600V, f = 1MHz, T_J = 25^{\circ}C$	C C		30.1 29.8		pF pF

# THERMAL RESISTANCE PERFORMANCE

Item	Symbol	Min.	Тур.	Max.	Unit
Thermal Resistance, Junction to Case	$R_{\theta,JC}$		1.254		K/W



#### REFERENCE DATA A TYPICAL PERFORMANCE

Fig. 1 - Typical Forward Characteristics I<sub>F</sub> vs. V<sub>F</sub>

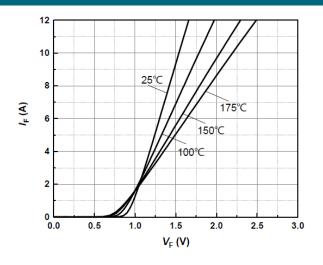


Fig. 2 • Typical Reverse Current I<sub>R</sub> as function of Reverse Voltage V<sub>R</sub>

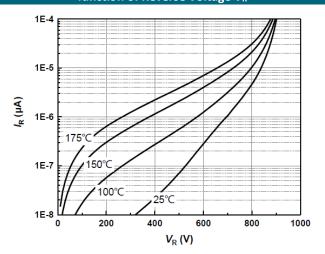


Fig. 3 • Diode Forward Current I<sub>F</sub> as function of Case Temperature T<sub>C</sub> (D = Duty Cycle)

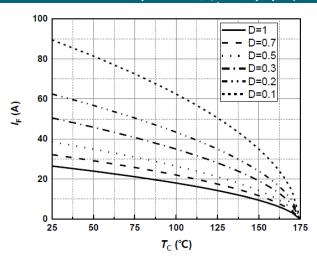


Fig. 4 • Typical Capacitance C as function of Reverse Voltage V<sub>R</sub>, C = f(V<sub>R</sub>), T<sub>J</sub> = 25°C, f = 1MHz

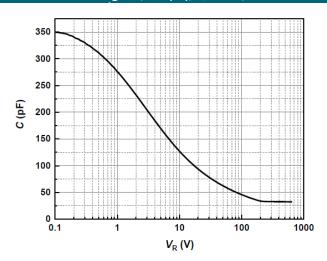


Fig. 5 • Typical Reverse Charge Q<sub>C</sub> as function of Reverse Voltage V<sub>R</sub>

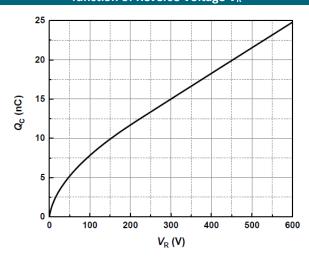
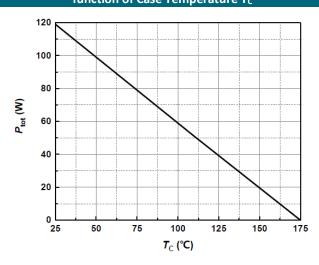


Fig. 6 • Power Dissipation P<sub>TOT</sub> as function of Case Temperature T<sub>C</sub>



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#### REFERENCE DATA A TYPICAL PERFORMANCE

Fig. 7 - Capacitance Stored Energy

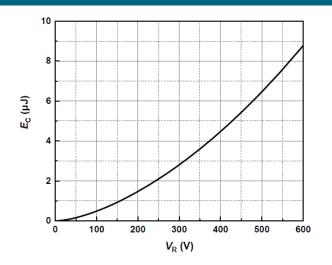
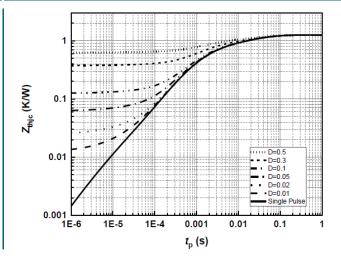
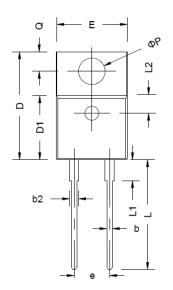


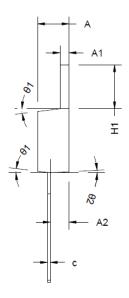
Fig. 8 • Maximum Transient Thermal Impedance, Z<sub>thjc</sub> = f(t), Parameter: D = t/T

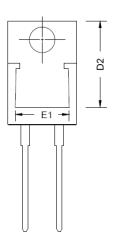


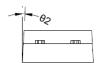


# **PACKAGE OUTLINE**









Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
_			
Α	4.37	4.57	4.77
A1	1.22	-	1.40
A2	2.49	2.69	2.89
b	0.75	-	0.96
b2	1.22	-	1.47
С	0.30	-	0.48
D	15.15	15.45	15.75
D1	9.05	9.15	9.25
D2	11.40	-	12.88
Е	9.86	10.16	10.36

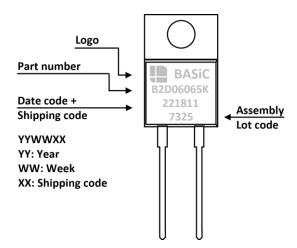
Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
E1	6.86	-	8.89
е	4.98	5.08	5.18
H1	6.10	6.30	6.50
L	12.70	-	13.70
L1	-	-	4.10
L2	2.50 REF		
ØΡ	3.70	3.84	3.99
Q	2.54	-	2.94
θ1	5°	7°	9°
θ2	1°	3°	5°

# **ORDERING INFORMATION**

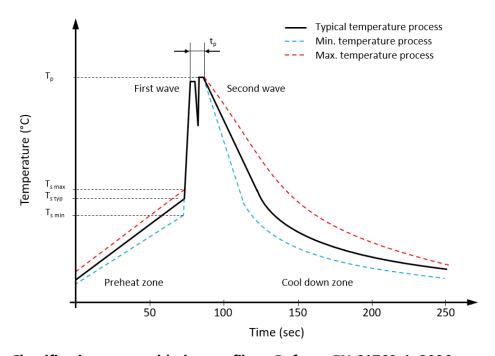
Part Number	Package	Packing	Tube Qty.	Inner Box Qty.	Outer Box Qty.
B2D06065K	TO-220-21	Tuhe	50pcs	500pcs	5.000pcs



#### **PART MARKING**



# RECOMMENDED WAVE SOLDERING PROFILE & THT PACKAGE



# Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value ▲ Sn-Pb Assembly	Value ▲ Pb-free Assembly
Preheat temperature min.	$T_{smin}$	100 °C	100 °C
Preheat temperature typical	T <sub>s typ</sub>	120 °C	120 °C
Preheat temperature max.	$T_{smax}$	130 °C	130 °C
Preheat time $t_s$ from $T_{smin}$ to $T_{smax}$	ts	70 seconds	70 seconds
Peak temperature	$T_p$	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	tp	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes

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#### **REVISION TABLE**

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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